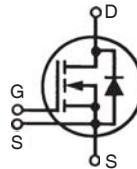


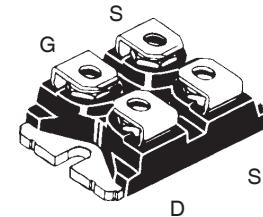
**X2-Class HiPerFET™  
Power MOSFET**
**IXFN120N65X2**

N-Channel Enhancement Mode  
Avalanche Rated  
Fast Intrinsic Diode



**V<sub>DSS</sub>** = 650V  
**I<sub>D25</sub>** = 108A  
**R<sub>DS(on)</sub>** ≤ 24mΩ

miniBLOC, SOT-227  
E153432



G = Gate      D = Drain  
S = Source

Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	650		V
V <sub>DGR</sub>	T <sub>J</sub> = 25°C to 150°C, R <sub>GS</sub> = 1MΩ	650		V
V <sub>GSS</sub>	Continuous	± 30		V
V <sub>GSM</sub>	Transient	± 40		V
I <sub>D25</sub>	T <sub>C</sub> = 25°C	108		A
I <sub>DM</sub>	T <sub>C</sub> = 25°C, Pulse Width Limited by T <sub>JM</sub>	240		A
I <sub>A</sub>	T <sub>C</sub> = 25°C	15		A
E <sub>AS</sub>	T <sub>C</sub> = 25°C	3.5		J
P <sub>D</sub>	T <sub>C</sub> = 25°C	890		W
dv/dt	I <sub>S</sub> ≤ I <sub>DM</sub> , V <sub>DD</sub> ≤ V <sub>DSS</sub> , T <sub>J</sub> ≤ 150°C	50		V/ns
T <sub>J</sub>		-55 ... +150		°C
T <sub>JM</sub>		150		°C
T <sub>stg</sub>		-55 ... +150		°C
V <sub>ISOL</sub>	50/60 Hz, RMS	t = 1 minute	2500	V~
	I <sub>ISOL</sub> ≤ 1mA	t = 1 second	3000	V~
M <sub>d</sub>	Mounting Torque	1.5/13	Nm/lb.in	
	Terminal Connection Torque	1.3/11.5	Nm/lb.in	
Weight		30		g

Symbol	Test Conditions (T <sub>J</sub> = 25°C Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 3mA	650		V
V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 8mA	3.5		V
I <sub>GSS</sub>	V <sub>GS</sub> = ± 30V, V <sub>DS</sub> = 0V		± 100	nA
I <sub>DSS</sub>	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0V		50	μA
	T <sub>J</sub> = 125°C		5	mA
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 60A, Note 1		24	mΩ

**Features**

- International Standard Package
- miniBLOC, with Aluminium Nitride Isolation
- Isolation Voltage 2500 V~
- High Current Handling Capability
- Fast Intrinsic Diode
- Avalanche Rated
- Low R<sub>DS(on)</sub>

**Advantages**

- High Power Density
- Easy to Mount
- Space Savings

**Applications**

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- PFC Circuits
- AC and DC Motor Drives
- Robotics and Servo Controls

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max
<b>I<sub>fs</sub></b>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 60A, Note 1	46	76	S
R <sub>Gi</sub>	Gate Input Resistance		0.74	Ω
C <sub>iss</sub>		14		nF
C <sub>oss</sub>		8700		pF
C <sub>rss</sub>		5.5		pF
<b>Effective Output Capacitance</b>				
C <sub>o(er)</sub>	Energy related } V <sub>GS</sub> = 0V	455		pF
C <sub>o(tr)</sub>	Time related } V <sub>DS</sub> = 0.8 • V <sub>DSS</sub>	1930		pF
t <sub>d(on)</sub>		39		ns
t <sub>r</sub>		26		ns
t <sub>d(off)</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 60A	82		ns
t <sub>f</sub>	R <sub>G</sub> = 1Ω (External)	12		ns
Q <sub>g(on)</sub>		240		nC
Q <sub>gs</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5 • V <sub>DSS</sub> , I <sub>D</sub> = 60A	87		nC
Q <sub>gd</sub>		65		nC
R <sub>thJC</sub>			0.14 °C/W	
R <sub>thCS</sub>		0.05		°C/W

### Source-Drain Diode

Symbol	Test Conditions (T <sub>J</sub> = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I <sub>s</sub>	V <sub>GS</sub> = 0V		120	A
I <sub>SM</sub>	Repetitive, Pulse Width Limited by T <sub>JM</sub>		480	A
V <sub>SD</sub>	I <sub>F</sub> = I <sub>S</sub> , V <sub>GS</sub> = 0V, Note 1		1.4	V
t <sub>rr</sub>		220		ns
Q <sub>RM</sub>	I <sub>F</sub> = 60A, -di/dt = 100A/μs	2.3		μC
I <sub>RM</sub>	V <sub>R</sub> = 100V, V <sub>GS</sub> = 0V	21.0		A

Note 1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

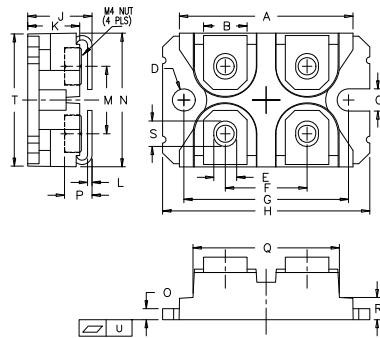
### PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

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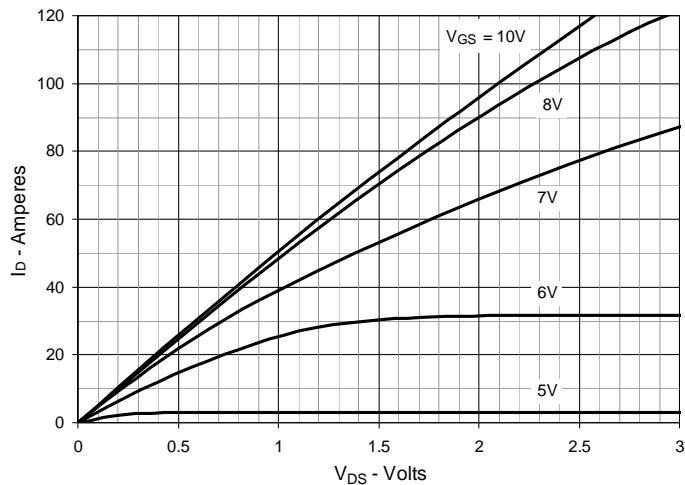
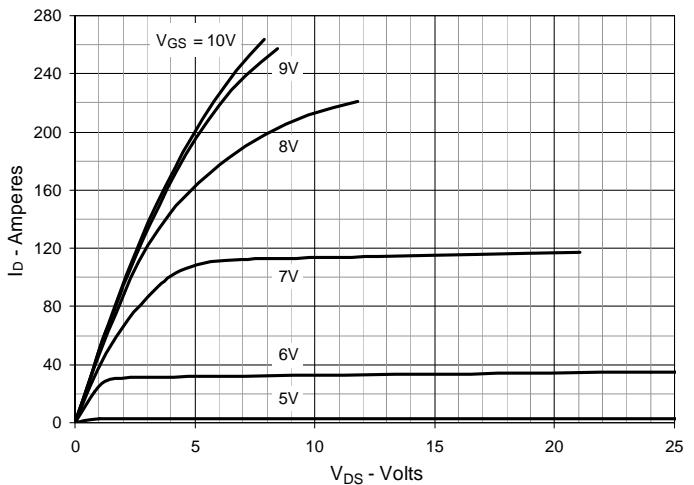
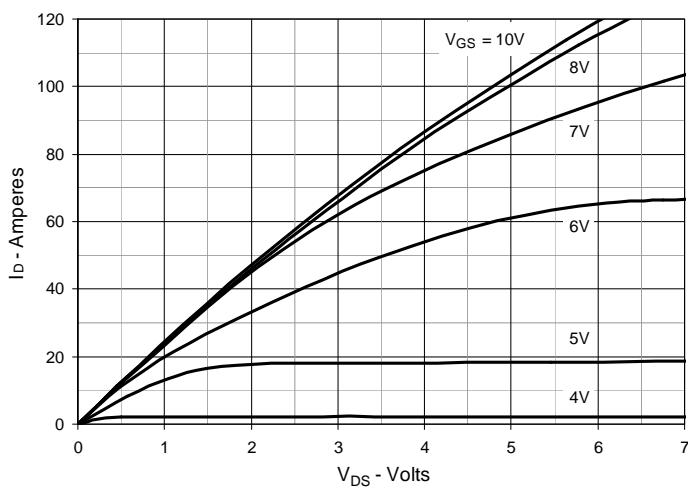
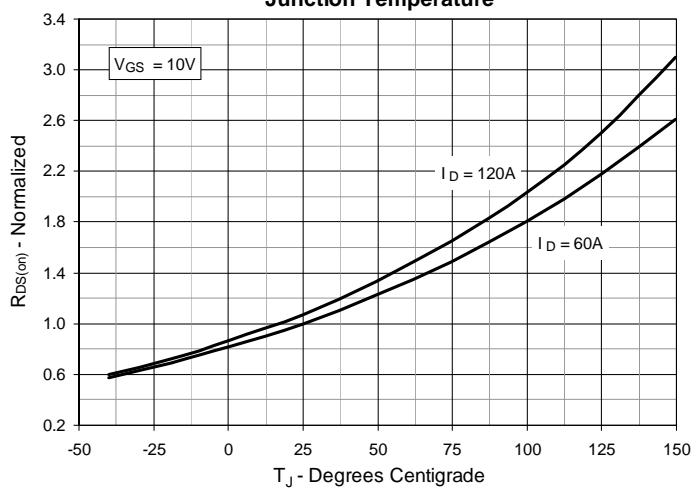
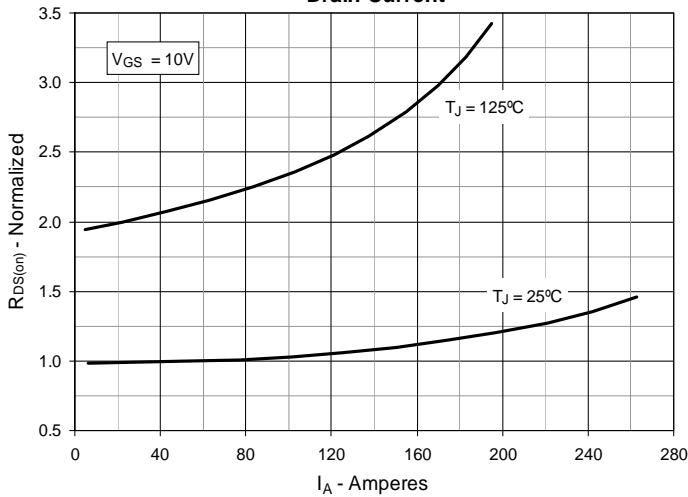
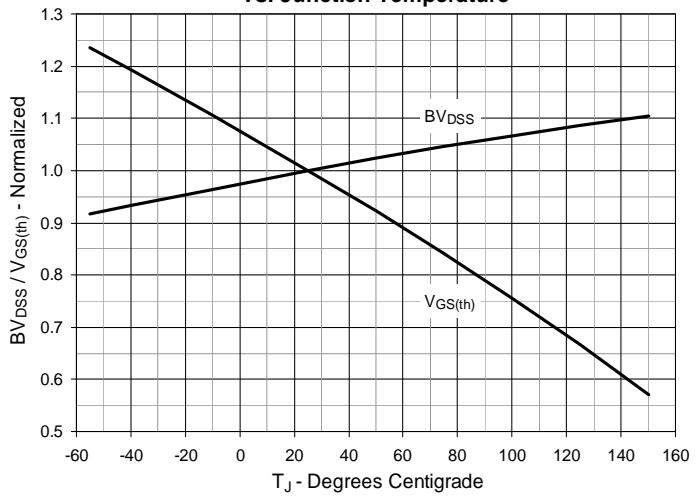
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

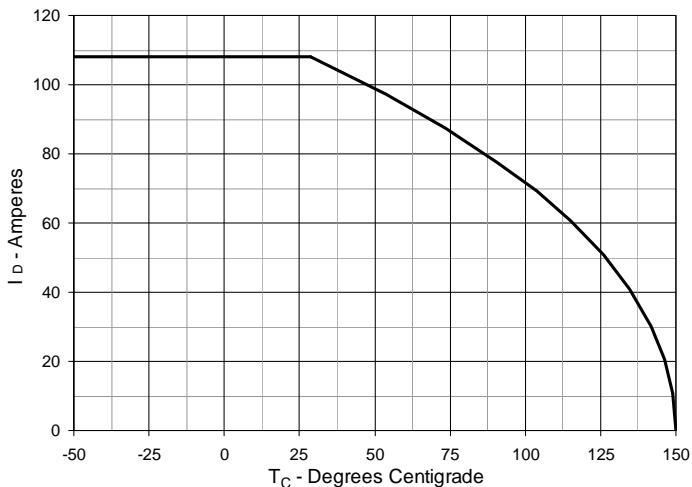
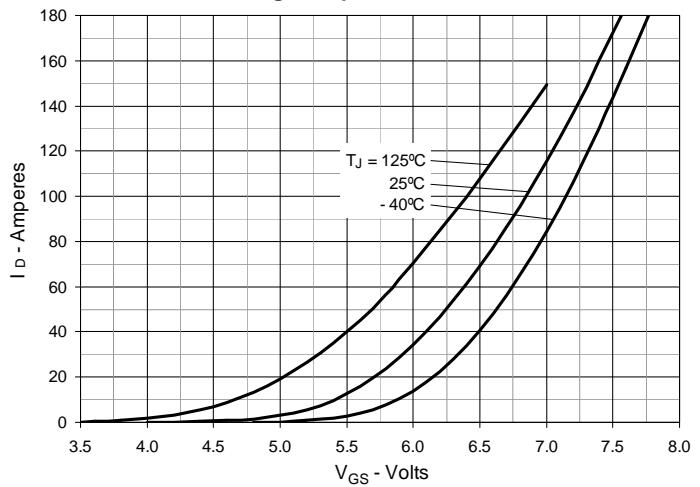
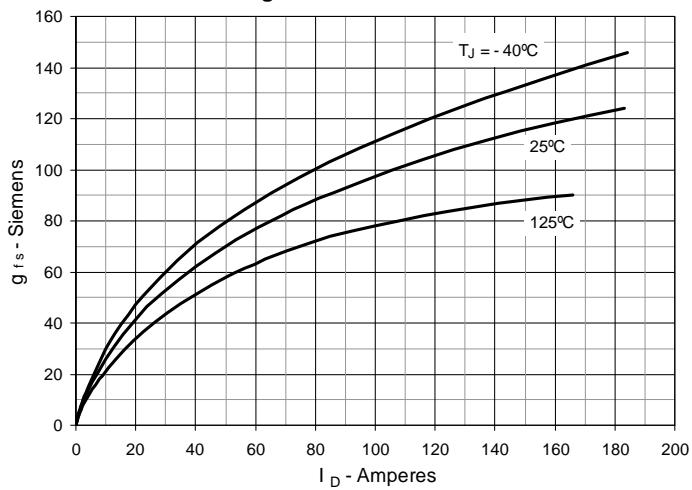
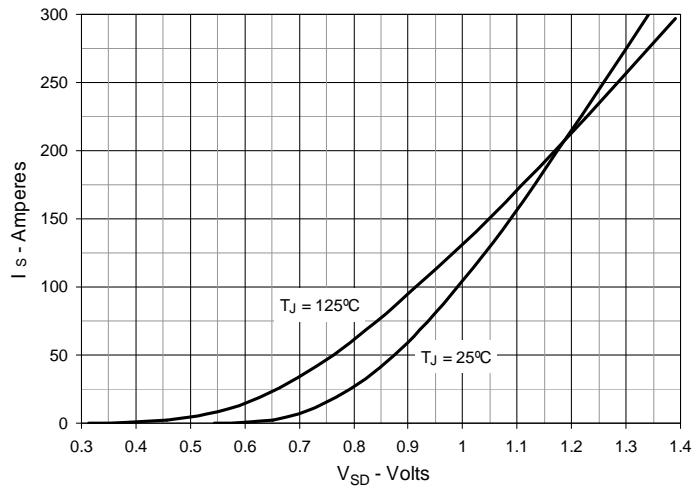
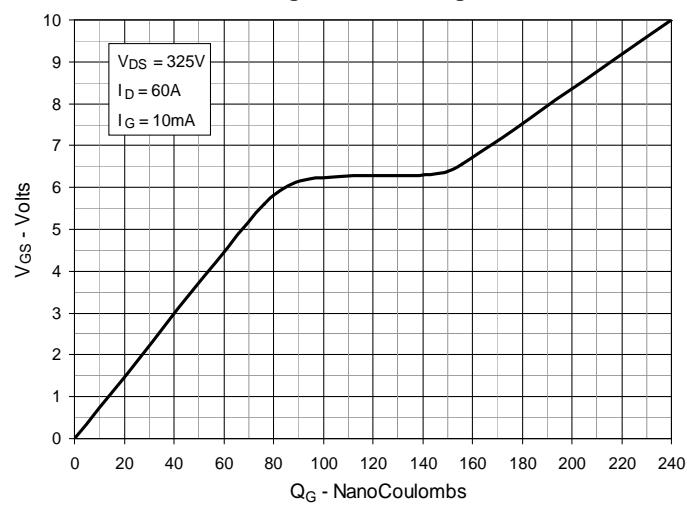
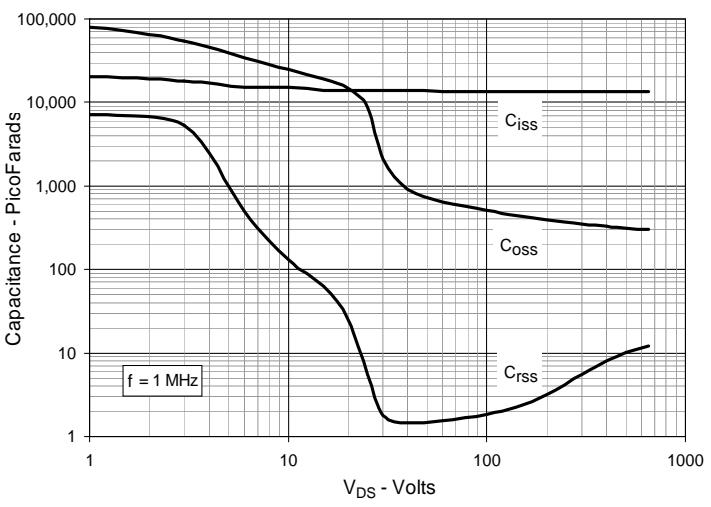
### SOT-227B (IXFN) Outline

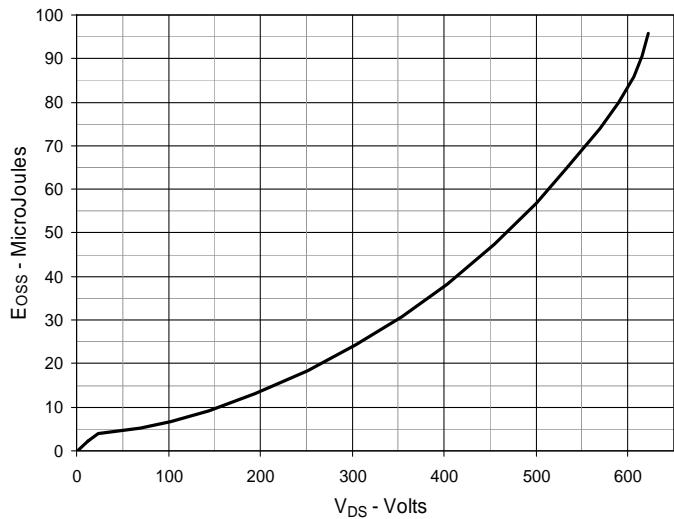
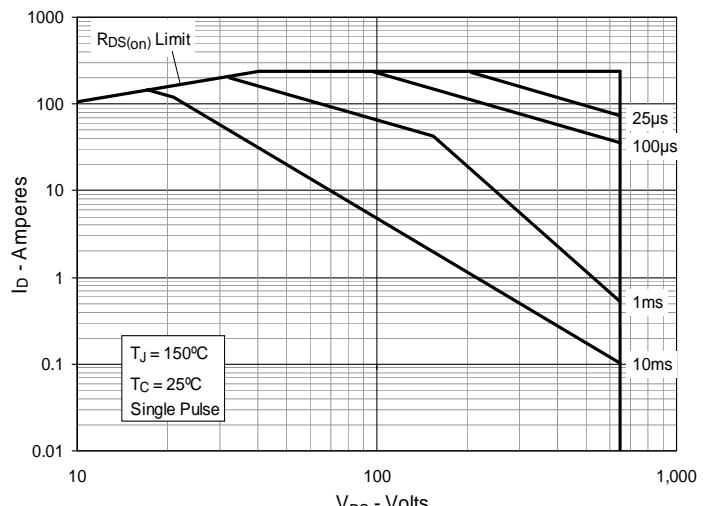


(M4 screws (4x) supplied)

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	1.240	1.255	31.50	31.88
B	.307	.323	7.80	8.20
C	.161	.169	4.09	4.29
D	.161	.169	4.09	4.29
E	.161	.169	4.09	4.29
F	.587	.595	14.91	15.11
G	1.186	1.193	30.12	30.30
H	1.496	1.505	38.00	38.23
J	.460	.481	11.68	12.22
K	.351	.378	8.92	9.60
L	.030	.033	.76	.84
M	.496	.506	12.60	12.85
N	.990	1.001	25.15	25.42
O	.078	.084	1.98	2.13
P	.195	.235	4.95	5.97
Q	1.045	1.059	26.54	26.90
R	.155	.174	3.94	4.42
S	.186	.191	4.72	4.85
T	.968	.987	24.59	25.07
U	-.002	.004	-0.05	0.1

**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$** 

**Fig. 3. Output Characteristics @  $T_J = 125^\circ\text{C}$** 

**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 60\text{A}$  Value vs. Junction Temperature**

**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 60\text{A}$  Value vs. Drain Current**

**Fig. 6. Normalized Breakdown & Threshold Voltages vs. Junction Temperature**


**Fig. 7. Maximum Drain Current vs. Case Temperature****Fig. 8. Input Admittance****Fig. 9. Transconductance****Fig. 10. Forward Voltage Drop of Intrinsic Diode****Fig. 11. Gate Charge****Fig. 12. Capacitance**

**Fig. 13. Output Capacitance Stored Energy****Fig. 14. Forward-Bias Safe Operating Area****Fig. 15. Maximum Transient Thermal Impedance**